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CMOS Digital Integrated Circuits Silicon Monolithic

74VHC164FT

1. Functional Description

• 8-Bit Shift Register (S-IN, P-OUT)

2. General

The 74VHC164FT is an advanced high speed CMOS 8-BIT SERIAL-IN PARALLEL-OUT SHIFT REGISTER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

It consists of serial-in, parallel-out 8-bit shift register with a CLOCK input and an overriding $\overline{\text{CLEAR}}$ input.

Two serial data inputs (A, B) are provided so that one may be used as a data enable.

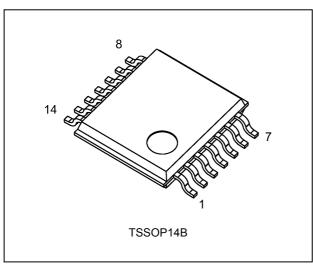
An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

3. Features

- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature range: $T_{opr} = -40$ to 125 °C
- (3) High speed: $f_{MAX} = 175 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- (4) Low power dissipation: $I_{CC} = 4.0 \mu A \text{ (max)}$ at $T_a = 25 \text{ °C}$
- (5) High noise immunity: $V_{NIH} = V_{NIL} = 28 \% V_{CC}$ (min)
- (6) Power-down protection is provided on all inputs.
- (7) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (8) Wide operating voltage range: $V_{CC(opr)} = 2.0 \text{ V}$ to 5.5 V
- (9) Low noise: $V_{OLP} = 0.8 \text{ V (max)}$
- (10) Pin and function compatible with the 74 series (AC/HC/AHC etc.) 164 type.

Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

4. Packaging

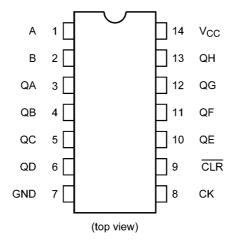


Start of commercial production

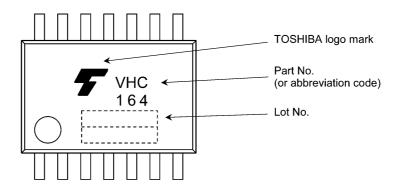
Rev.4.0



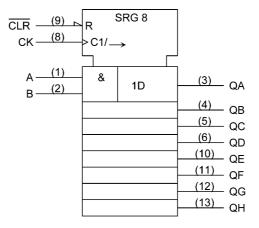
5. Pin Assignment



6. Marking



7. IEC Logic Symbol





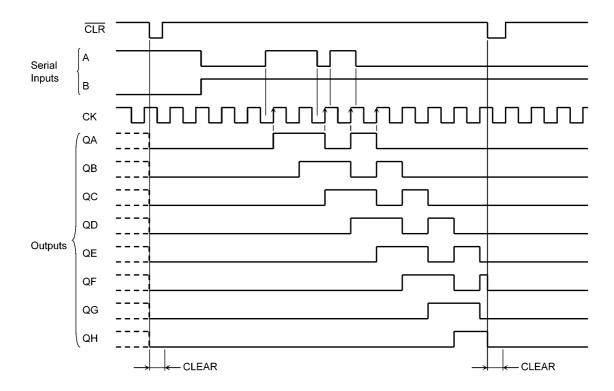
8. Truth Table

	Inputs				Out	puts	
CLR	LR CK Serial IN QA		QA	QB		QH	
CLK	S	A	В	QA	מ		QII
L	Х	Х	Х	L	L		L
Н	_	Х	Х		No Cl	nange	
Н		L	Х	L	QAn	•••	QGn
Н		Х	L	L	QAn		QGn
Н	<u></u>	Ι	Н	Н	QAn	::	QGn

X: Don't care

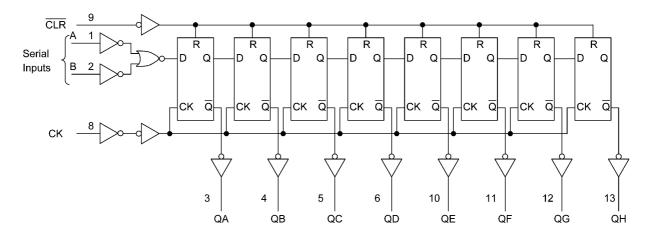
 QA_{n} to QG_{n} : The level of QA to QG , respectively, before the most recent positive edge of the CK.

9. Timing Diagrams





10. System Diagram



11. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note		
Supply voltage	V _{CC}		-0.5 to 7.0	V
Input voltage	V_{IN}		-0.5 to 7.0	V
Output voltage	V _{OUT}		-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}		-20	mA
Output diode current	lok		±20	mA
Output current	I _{OUT}		±25	mA
V _{CC} /ground current	I _{CC}		±75	mA
Power dissipation	P_D	(Note 1)	180	mW
Storage temperature	T _{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

12. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V _{CC}		2.0 to 5.5	V
Input voltage	V _{IN}		0 to 5.5	V
Output voltage	V _{OUT}		0 to V _{CC}	V
Operating temperature	T _{opr}		-40 to 125	°C
Input rise and fall times	dt/dv	V_{CC} = 3.3 ± 0.3 V	0 to 100	ns/V
		$V_{CC} = 5 \pm 0.5 \text{ V}$	0 to 20	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



13. Electrical Characteristics

13.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	_	
Low-level input voltage	V _{IL}	_		2.0	_		0.50	V
				3.0 to 5.5	_		$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I_{OH} = -50 μ A	2.0	1.9	2.0	_	V
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I_{OH} = -4 mA	3.0	2.58	_	_	
			I _{OH} = -8 mA	4.5	3.94		_	
Low-level output voltage	V _{OL}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OL} = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I_{OL} = 4 mA	3.0	_	_	0.36	
			I _{OL} = 8 mA	4.5	_		0.36	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_		±0.1	μΑ
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		5.5	_	_	4.0	μΑ

13.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Cond	dition	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				3.0 to 5.5	_	$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	_	V
				3.0	2.9	_	
				4.5	4.4	_	
			I _{OH} = -4 mA	3.0	2.48	_	
			$I_{OH} = -8 \text{ mA}$	4.5	3.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.1	V
				3.0	_	0.1	
				4.5	_	0.1	
			I _{OL} = 4 mA	3.0	_	0.44	
			I _{OL} = 8 mA	4.5	_	0.44	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5		±1.0	μΑ
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		5.5		40.0	μΑ



13.3. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Conditi	on	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				3.0 to 5.5	_	$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -50 μA	2.0	1.9	_	٧
				3.0	2.9	_	
				4.5	4.4	_	
			I _{OH} = -4 mA	3.0	2.40	_	
			I_{OH} = -8 mA	4.5	3.70	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.1	٧
				3.0	_	0.1	
				4.5	_	0.1	
			I _{OL} = 4 mA	3.0	_	0.55	
			I _{OL} = 8 mA	4.5	_	0.55	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5	_	±2.0	μΑ
Quiescent supply current	I _{CC}	V _{IN} = V _{CC} or GND		5.5	_	80.0	μΑ

13.4. Timing Requirements (Unless otherwise specified, $T_a = 25$ °C, Input: $t_f = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)}, t_{w(H)}$	_	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	5.0	
Minimum pulse width (CLR)	t _{w(L)}	_	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	5.0	
Minimum setup time	t _S	_	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	4.5	
Minimum hold time	t _h	_	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	1.0	
Minimum removal time (CLR)	t _{rem}	_	3.3 ± 0.3	2.5	ns
			5.0 ± 0.5	2.5	

13.5. Timing Requirements (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)}, t_{w(H)}$	_	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	5.0	
Minimum pulse width (CLR)	t _{w(L)}	_	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	5.0	
Minimum setup time	t _S	_	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	4.5	
Minimum hold time	t _h	_	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	1.0	
Minimum removal time (CLR)	t _{rem}	_	3.3 ± 0.3	2.5	ns
			5.0 ± 0.5	2.5	



13.6. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width (CK)	$t_{w(L)}, t_{w(H)}$	_	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	5.0	
Minimum pulse width (CLR)	t _{w(L)}	_	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	5.0	
Minimum setup time	t _S	_	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	4.5	
Minimum hold time	t _h	_	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	1.0	
Minimum removal time (CLR)	t _{rem}	_	3.3 ± 0.3	3.5	ns
			5.0 ± 0.5	3.0	

13.7. AC Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Unit
Propagation delay time (CK-Q)	t _{PLH} ,t _{PHL}		_	3.3 ± 0.3	15	_	8.4	12.8	ns
					50	_	10.9	16.3	
				5.0 ± 0.5	15	_	5.8	9.0	
					50	_	7.3	11.0	
Propagation delay time (CLR-Q)	t _{PHL}		_	3.3 ± 0.3	15	_	8.3	12.8	ns
					50	_	10.8	16.3	
				5.0 ± 0.5	15	_	5.2	8.6	
					50	_	6.7	10.6	
Maximum clock frequency	f _{MAX}		_	3.3 ± 0.3	15	80	125	_	MHz
					50	50	75		
				5.0 ± 0.5	15	125	175		
					50	85	115	_	
Input capacitance	C _{IN}		_			_	4	10	pF
Power dissipation capacitance	C _{PD}	(Note 1)	_			_	76	_	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}$

13.8. AC Characteristics

(Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time (CK-Q)	t_{PLH}, t_{PHL}	_	3.3 ± 0.3	15	1.0	15.0	ns
				50	1.0	18.5	
			5.0 ± 0.5	15	1.0	10.5	
				50	1.0	12.5	
Propagation delay time (CLR-Q)	t _{PHL}	_	3.3 ± 0.3	15	1.0	15.0	ns
				50	1.0	18.5	
			5.0 ± 0.5	15	1.0	10.0	
				50	1.0	12.0	
Maximum clock frequency	f _{MAX}	_	3.3 ± 0.3	15	65	_	MHz
				50	45	_	
			5.0 ± 0.5	15	105	_	
				50	75	_	
Input capacitance	C _{IN}	_			1	10	pF



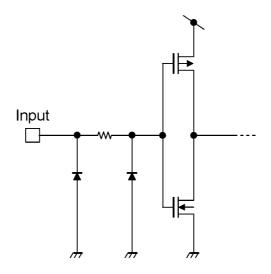
13.9. AC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time (CK-Q)	t _{PLH} ,t _{PHL}	_	3.3 ± 0.3	15	1.0	17.0	ns
				50	1.0	20.5	
			5.0 ± 0.5	15	1.0	12.0	
				50	1.0	14.0	
Propagation delay time (CLR-Q)	t _{PHL}	_	3.3 ± 0.3	15	1.0	17.0	ns
				50	1.0	20.5	
			5.0 ± 0.5	15	1.0	11.5	
				50	1.0	13.5	
Maximum clock frequency	f _{MAX}	_	3.3 ± 0.3	15	60	_	MHz
				50	40	_	
			5.0 ± 0.5	15	100	_	
				50	65	_	
Input capacitance	C _{IN}	_			1	10	pF

13.10. Noise Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Тур.	Limit	Unit
Quiet output maximum dynamic V _{OL}	V _{OLP}	C _L = 50 pF	5.0	0.5	0.8	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	C _L = 50 pF	5.0	-0.5	-0.8	V
Minimum high-level dynamic input voltage	V _{IHD}	C _L = 50 pF	5.0	_	3.5	V
Maximum low-level dynamic input voltage	V_{ILD}	C _L = 50 pF	5.0	_	1.5	V

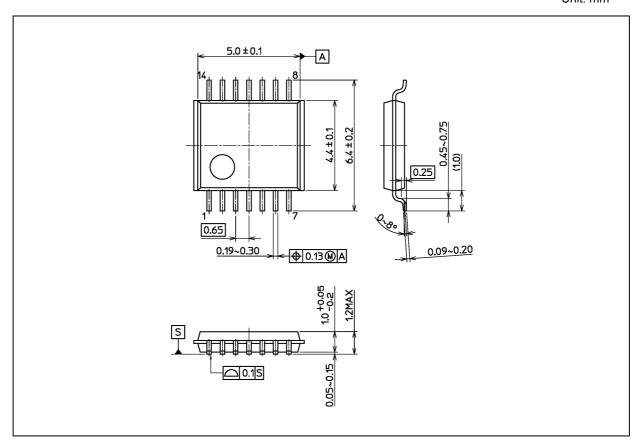
14. Internal Equivalent Circuit





Package Dimensions

Unit: mm



Weight: 0.054 g (typ.)

Package Name(s)
lickname: TSSOP14B



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